

Trench gate field-stop IGBT, M series 650 V, 6 A low loss

Datasheet - production data

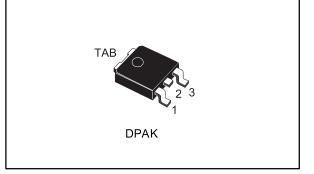
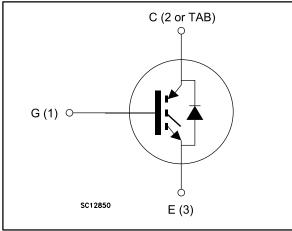


Figure 1: Internal schematic diagram



Features

- 6 µs of short-circuit withstand time
- V_{CE(sat)} = 1.55 V (typ.) @ I_C = 6 A
- Tight parameter distribution
- Safer paralleling
- Low thermal resistance
- Soft and very fast recovery antiparallel diode

Applications

- Motor control
- UPS
- PFC

Description

This device is an IGBT developed using an advanced proprietary trench gate field-stop structure. The device is part of the M series IGBTs, which represent an optimal balance between inverter system performance and efficiency where low-loss and short-circuit functionality are essential. Furthermore, the positive $V_{CE(sat)}$ temperature coefficient and tight parameter distribution result in safer paralleling operation.

Table 1: Device summary

Order code	Marking	Package	Packing
STGD6M65DF2	G6M65DF2	DPAK	Tape and reel

This is information on a product in full production.

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1 Electrical ratings

Table 2: Absolute maximum ratings

Symbol	Parameter	Value	Unit
VCES	Collector-emitter voltage (V _{GE} = 0 V)	650	V
1-	Continuous collector current at $T_C = 25 \text{ °C}$	12	А
lc	Continuous collector current at T _c = 100 °C	6	А
ICP ⁽¹⁾	Pulsed collector current	24	А
V_{GE}	Gate-emitter voltage	±20	V
	Continuous forward current at T _c = 25 °C	12	А
IF	Continuous forward current at T _C = 100 °C	6	А
I _{FP} ⁽¹⁾	Pulsed forward current	24	А
Ртот	Total dissipation at Tc = 25 °C	88	W
Tstg	Storage temperature range	- 55 to 150	°C
TJ	Operating junction temperature range	- 55 to 175	°C

Notes:

 $^{(1)}\mbox{Pulse}$ width limited by maximum junction temperature.

Table 3: Thermal data

Symbol	Parameter	Value	Unit
RthJC	Thermal resistance junction-case IGBT	1.7	°C/W
RthJC	Thermal resistance junction-case diode	5	°C/W
RthJA	Thermal resistance junction-ambient	100	°C/W



 $T_C = 25$ °C unless otherwise specified

I able 4: Static characteristics						
Symbol	Parameter	Test conditions	Min.	Тур.	Max.	Unit
$V_{(BR)CES}$	Collector-emitter breakdown voltage	$V_{GE}=0~V,~I_C=250~\mu A$	650			V
		V_{GE} = 15 V, I_C = 6 A		1.55	2.0	
V _{CE(sat)}	Collector-emitter saturation voltage	$V_{GE} = 15 \text{ V}, \text{ Ic} = 6 \text{ A}, T_J = 125 \text{ °C}$		1.9		v
	voltage	$V_{GE} = 15 \text{ V}, \text{ I}_{C} = 6 \text{ A},$ T _J = 175 °C		2.1		
		IF = 6 A		2.2		
VF	Forward on-voltage	I _F = 6 A, T _J = 125 °C		2.0		V
		I⊧ = 6 A, TJ = 175 °C		1.9		
$V_{\text{GE(th)}}$	Gate threshold voltage	$V_{CE} = V_{GE}, I_C = 250 \ \mu A$	5	6	7	V
ICES	Collector cut-off current	$V_{GE} = 0 V, V_{CE} = 650 V$			25	μA
I _{GES}	Gate-emitter leakage current	$V_{CE}=0~V,~V_{GE}=\pm~20~V$			±250	μΑ

Table 4: Static characteristics

Table 5: Dynamic characteristics

Symbol	Parameter	Test conditions	Min.	Тур.	Max.	Unit
Cies	Input capacitance		-	530	-	
C _{oes}	Output capacitance	V_{CE} = 25 V, f = 1 MHz, V_{GE} = 0 V	-	31	-	pF
Cres	Reverse transfer capacitance	-		11	-	
Qg	Total gate charge		-	21.2	-	
Q _{ge}	Gate-emitter charge	$V_{CC} = 520 \text{ V}, I_C = 6 \text{ A}, V_{GE} = 15 \text{ V}$ (see Figure 30: " Gate charge test	-	5.2	-	nC
Q _{gc}	Gate-collector charge	circuit")	-	8.8	-	

Electrical characteristics

	Table 6: IGBT switching characteristics (inductive load)					
Symbol	Parameter	Test conditions	Min.	Тур.	Max.	Unit
t _{d(on)}	Turn-on delay time			15	-	ns
tr	Current rise time			5.8	-	ns
(di/dt) _{on}	Turn-on current slope			828	-	A/µs
$t_{d(\text{off})}$	Turn-off-delay time			90	-	ns
t _f	Current fall time	$V_{CE} = 400 \text{ V}, \text{ Ic} = 6 \text{ A}, \text{ V}_{GE} = 15 \text{ V},$ $R_G = 22 \Omega \text{ (see Figure 29: "Test circuit}$ for inductive load switching")		130	-	ns
E _{on} ⁽¹⁾	Turn-on switching energy			0.036	-	mJ
E _{off} ⁽²⁾	Turn-off switching energy			0.200	-	mJ
Ets	Total switching energy			0.236	-	mJ
t _{d(on)}	Turn-on delay time			17	-	ns
tr	Current rise time			7	-	ns
(di/dt) _{on}	Turn-on current slope			685	-	A/µs
$t_{d(off)}$	Turn-off-delay time			86	-	ns
t _f	Current fall time	$V_{CE} = 400 \text{ V}, I_C = 6 \text{ A}, V_{GE} = 15 \text{ V},$ $R_G = 22 \Omega T_J = 175 \text{ °C} (\text{see Figure 29: "}$ Test circuit for inductive load switching")		205	-	ns
Eon ⁽¹⁾	Turn-on switching energy			0.064	-	mJ
E _{off} ⁽²⁾	Turn-off switching energy			0.290	-	mJ
E _{ts}	Total switching energy			0.354	-	mJ
t _{sc}	Short-circuit	$V_{CC} \le 400 \text{ V}, \text{ V}_{GE} = 15 \text{ V}, \text{ T}_{Jstart} = 150 ^{\circ}\text{C}$	6		-	μs
LSC	withstand time	V _{CC} ≤ 400 V, V _{GE} = 13 V, T _{Jstart} = 150 °C	10		-	μs

Notes:

 $^{(1)}\ensuremath{\mathsf{Turn}}\xspace$ on switching energy includes reverse recovery of the diode.

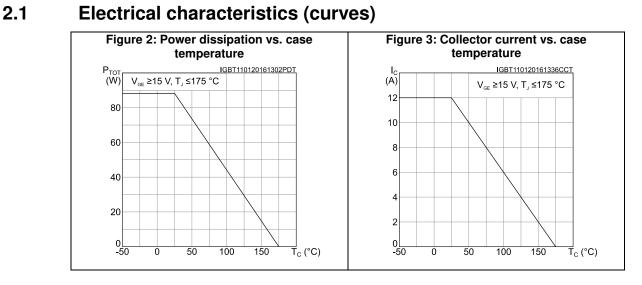
 $^{(2)}\mbox{Turn-off}$ switching energy also includes the tail of the collector current.

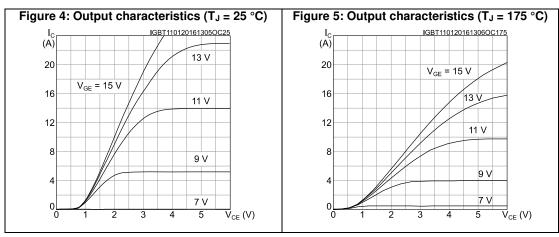


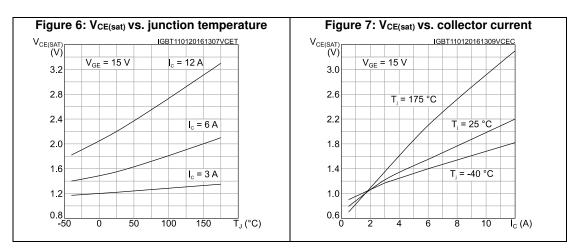
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Table 7: Diode switching characteristics (inductive load)						
Symbol	Parameter	Test conditions	Min.	Тур.	Max.	Unit
trr	Reverse recovery time		-	140	-	ns
Q _{rr}	Reverse recovery charge	-		210	-	nC
Irrm	Reverse recovery current	IF = 6 A, V _R = 400 V, V _{GE} = 15 V (see <i>Figure 29: " Test circuit for</i>	-	6.6	-	А
dlrr/dt	Peak rate of fall of reverse recovery current during t _b	inductive load switching") di/dt = 1000 A/μs		430	-	A/µs
Err	Reverse recovery energy			16	-	μJ
t _{rr}	Reverse recovery time			200	-	ns
Qrr	Reverse recovery charge		-	473	-	nC
Irrm	Reverse recovery current	$I_{F} = 6 \text{ A}, V_{R} = 400 \text{ V}, V_{GE} = 15 \text{ V}$ $T_{J} = 175 \text{ °C} (\text{see Figure 29: "Test}$ circuit for inductive load switching") di/dt = 1000 \text{ A}/\mu\text{s}		9.6	-	А
dlrr/dt	Peak rate of fall of reverse recovery current during t _b			428	-	A/µs
Err	Reverse recovery energy		-	32	-	μJ







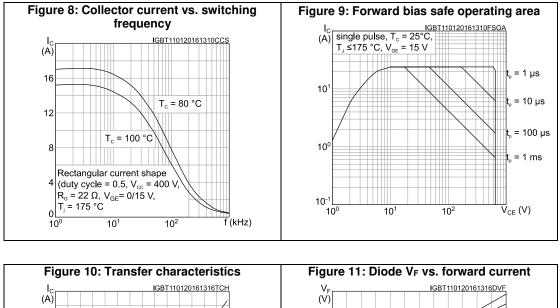


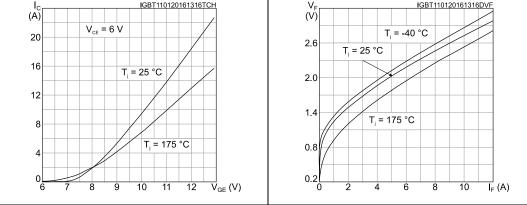
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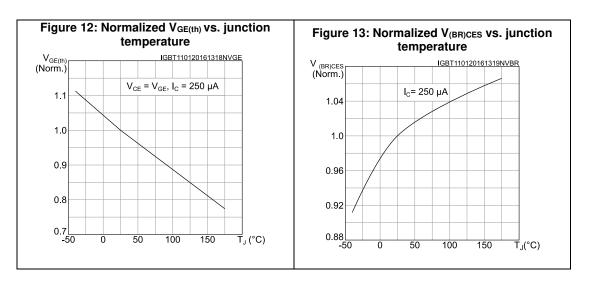
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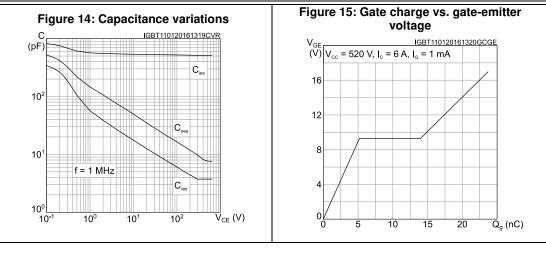
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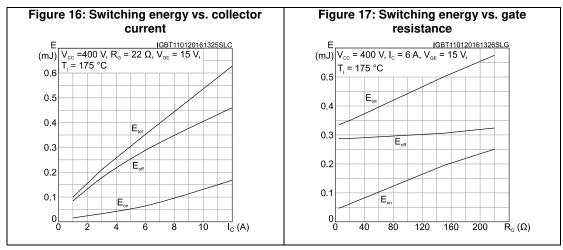


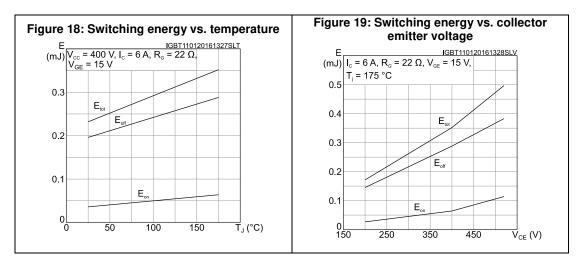






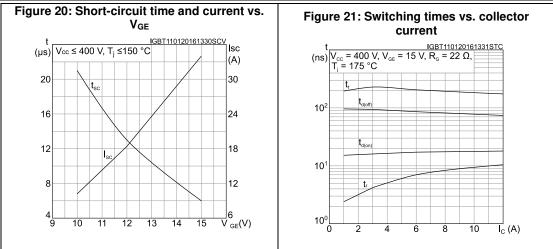


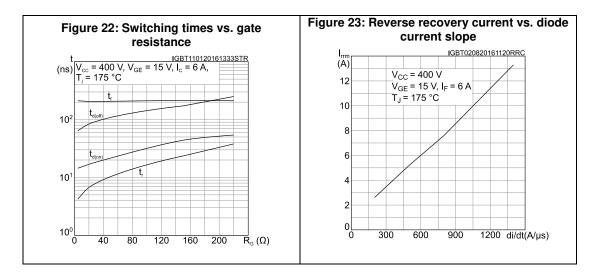


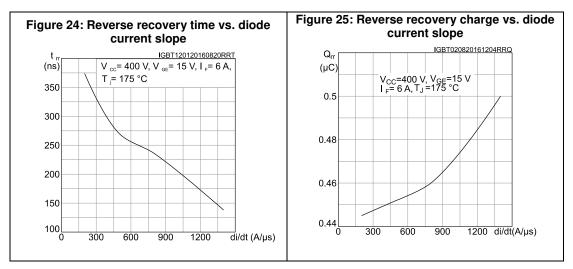


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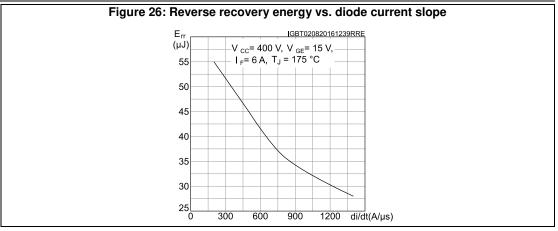


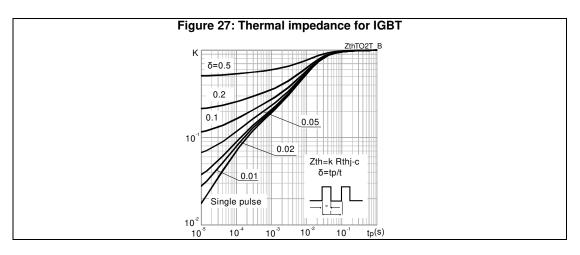


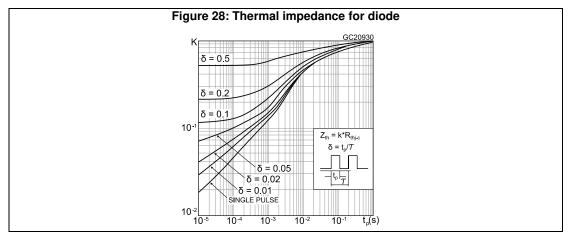




Electrical characteristics

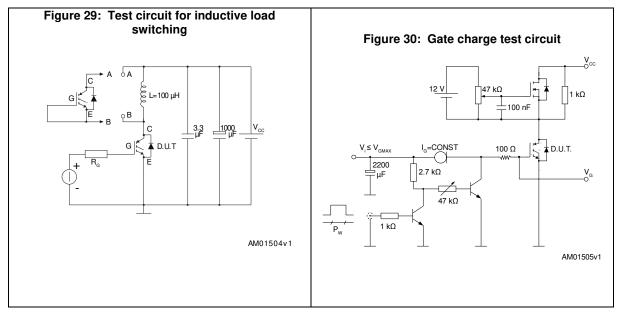


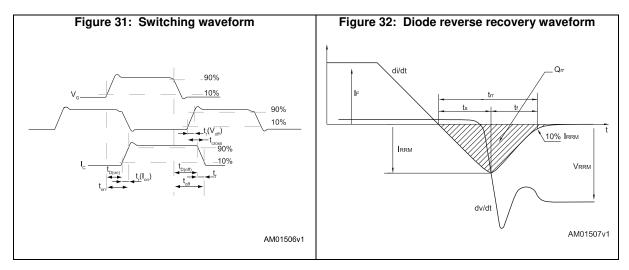




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3 Test circuits







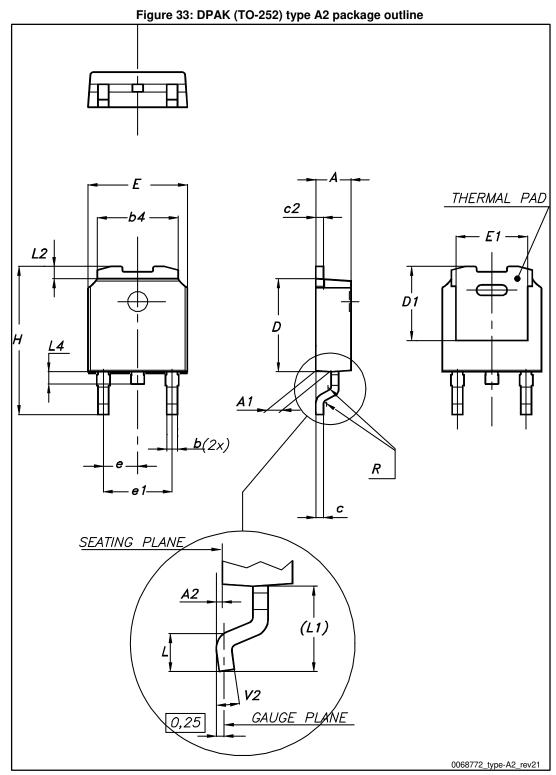
4 Package information

In order to meet environmental requirements, ST offers these devices in different grades of ECOPACK[®] packages, depending on their level of environmental compliance. ECOPACK[®] specifications, grade definitions and product status are available at: *www.st.com*. ECOPACK[®] is an ST trademark.



Package information







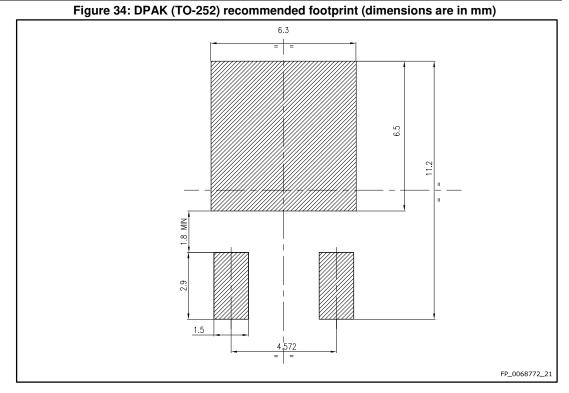
Package information

5DF2			Package information
	Table 8: DPAK (TO-252) type A2 mechanical da	ta
Dim.		mm	
Dini.	Min.	Тур.	Max.
А	2.20		2.40
A1	0.90		1.10
A2	0.03		0.23
b	0.64		0.90
b4	5.20		5.40
С	0.45		0.60
c2	0.48		0.60
D	6.00		6.20
D1	4.95	5.10	5.25
E	6.40		6.60
E1	5.10	5.20	5.30
е	2.16	2.28	2.40
e1	4.40		4.60
Н	9.35		10.10
L	1.00		1.50
L1	2.60	2.80	3.00
L2	0.65	0.80	0.95
L4	0.60		1.00
R		0.20	
V2	0°		8°



Package information

STGD6M65DF2





4.2 DPAK (TO-252) packing information

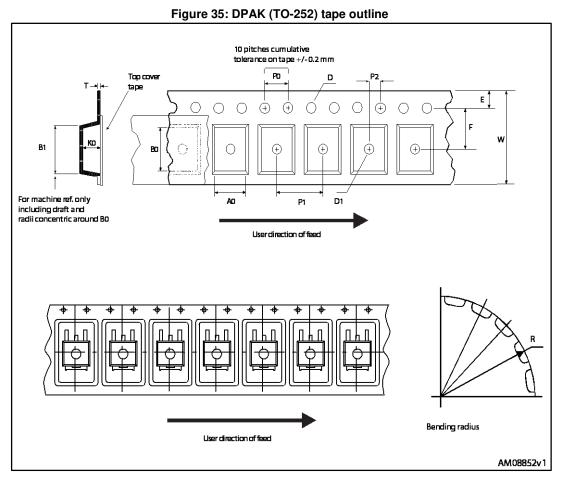




Figure 36: DPAK (TO-252) reel outline

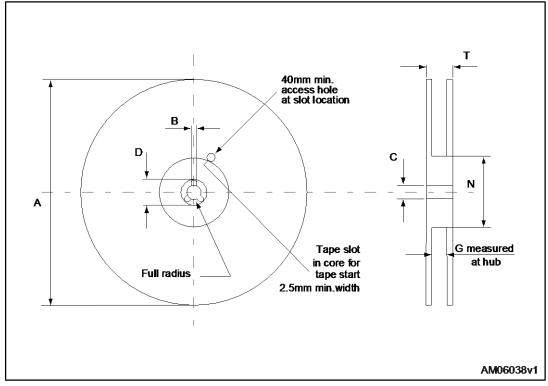


Table 9: DPAK (TO-252) tape and reel mechanical data					
	Таре			Reel	
Dim	mm		m	ım	
Dim.	Min.	Max.	Dim.	Min.	Max.
A0	6.8	7	A		330
B0	10.4	10.6	В	1.5	
B1		12.1	С	12.8	13.2
D	1.5	1.6	D	20.2	
D1	1.5		G	16.4	18.4
E	1.65	1.85	N	50	
F	7.4	7.6	Т		22.4
K0	2.55	2.75			
P0	3.9	4.1	Bas	e qty.	2500
P1	7.9	8.1	Bull	k qty.	2500
P2	1.9	2.1			
R	40				
Т	0.25	0.35			
W	15.7	16.3			

Table 9: DPAK (TO-252) tape and reel mechanical data



5 Revision history

Table 10: Document revision history	Table 10	: Document	revision	history
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Date	Revision	Changes
30-Nov-2015	1	First release.
13-Jan-2016	2	Modified: Table 4: "Static characteristics", Table 5: "Dynamic characteristics", Table 6: "IGBT switching characteristics (inductive load)" and Table 7: "Diode switching characteristics (inductive load)" Added: Section 2.1: "Electrical characteristics (curves)" Minor text changes
		Updated: Table 2: "Absolute maximum ratings", Table 4: "Static characteristics", Table 6: "IGBT switching characteristics (inductive load)", Table 7: "Diode switching characteristics (inductive load)". Updated Figure 9: "Forward bias safe operating area", Figure 12:
04-Aug-2016	04-Aug-2016 3	"Normalized VGE(th) vs. junction temperature", Figure 20: "Short-circuit time and current vs. VGE", Figure 23: "Reverse recovery current vs. diode current slope".
		Changed: <i>Figure 25: "Reverse recovery charge vs. diode current slope"</i> , and <i>Figure 26: "Reverse recovery energy vs. diode current slope"</i> .
		Document status promoted from preliminary to production data.



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